

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 7,426,900 B2
APPLICATION NO. : 10/716729
DATED : September 23, 2008
INVENTOR(S) : Brcka

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Title Page item 57

In the Abstract, at line 4, "prepare substrates for, and to process substrates by applying," should read -- prepare substrates for, and to process substrates by, applying --.

In Column 1, line 16, "sources, which utilizing" should read -- sources, which utilize --.

In Column 2, line 41, "the ICP sources with a spiral coil produces" should read -- ICP sources with spiral coils produce --.

In Column 3, line 56, "source is provided." should read -- source are provided. --.

In Column 4, line 59, "FIG. 6D, is a slot" should read -- FIG 6D is a slot --.

In Column 7, line 59, "which are practical and may be" should read -- which are practical may be --.

In Column 7, line 61, "I-ESIC device." should read -- i-ESIC device. --.

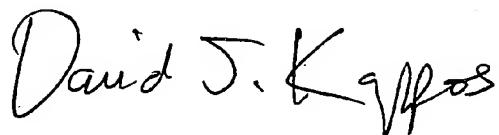
In Column 8, line 7, "C^{ccp}" should read -- C_{ccp} --.

In Column 9, line 11, "FIG. 6A-6B show" should read -- FIGS. 6A-6B show --.

In Column 9, lines 24-25, delete "Express Mail No. EV354971157US,".

Signed and Sealed this

Tenth Day of November, 2009



David J. Kappos
Director of the United States Patent and Trademark Office